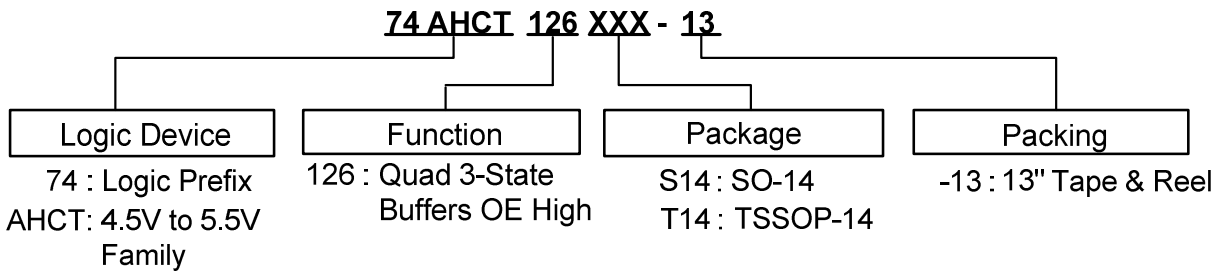


Ordering Information



Part Number	Package Code	Packaging	7" Tape and Reel	
			Quantity	Part Number Suffix
74AHCT126S14-13	S14	SO-14	2,500/Tape & Reel	-13
74AHCT126T14-13	T14	TSSOP-14	2,500/Tape & Reel	-13

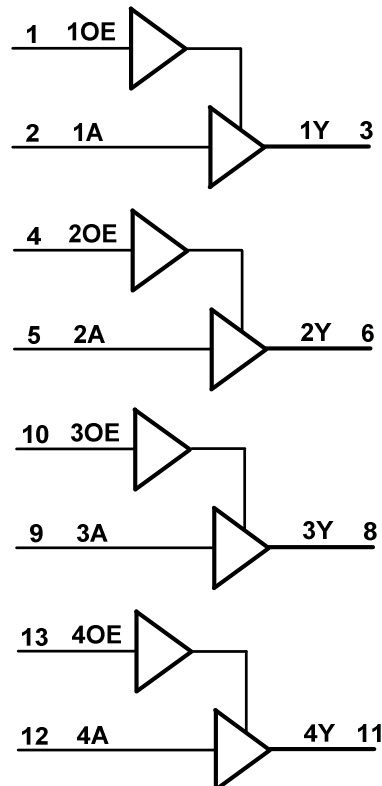
Pin Descriptions

Pin Number	Pin Name	Function
1	1OE	Data Enable Input (active high)
2	1A	Data Input
3	1Y	Data Output
4	2OE	Data Enable Input (active high)
5	2A	Data Input
6	2Y	Data Output
7	GND	Ground
8	3Y	Data Output
9	3A	Data Input
10	3OE	Data Enable Input (active high)
11	4Y	Data Output
12	4A	Data Input
13	4OE	Data Enable Input (active high)
14	V _{CC}	Supply Voltage

Function Table

Inputs		Output
OE	A	Y
H	H	H
H	L	L
L	X	Z

Logic Diagram



Absolute Maximum Ratings (Note 4) ($T_A = +25^\circ\text{C}$, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
ESD MM	Machine Model ESD Protection	200	V
V_{CC}	Supply Voltage Range	-0.5 to +7.0	V
V_I	Input Voltage Range	-0.5 to +7.0	V
I_{IK}	Input Clamp Current $V_I < -0.5\text{V}$	-20	mA
I_{OK}	Output Clamp Current $V_O < 0\text{V}$	-20	mA
I_{OK}	Output Clamp Current $V_O > V_{CC}$	20	mA
I_O	Continuous Output Current $0\text{V} < V_O < V_{CC}$	+/- 25	mA
I_{CC}	Continuous Current Through V_{CC}	50	mA
I_{GND}	Continuous Current Through GND	-50	mA
T_J	Operating Junction Temperature	-40 to +150	$^\circ\text{C}$
T_{STG}	Storage Temperature	-65 to +150	$^\circ\text{C}$
P_{TOT}	Total Power Dissipation	500	mW

Note: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

Recommended Operating Conditions (Note 5) ($T_A = +25^\circ\text{C}$, unless otherwise specified.)

Symbol	Parameter	Min	Max	Unit
V_{CC}	Supply Voltage	4.5	5.5	V
V_I	Input Voltage	0	5.5	V
V_O	Output Voltage	0	V_{CC}	V
$\Delta t/\Delta V$	Input transition Rise or Fall Rate	-	20	ns/V
T_A	Operating Free-Air Temperature	-40	+125	$^\circ\text{C}$

Note: 5. Unused inputs should be held at V_{CC} or Ground.

Electrical Characteristics

Symbol	Parameter	Test Conditions	V _{CC}	T _A = -40°C to +85°C		T _A = -40°C to +125°C		Unit
				Min	Max	Min	Max	
V _{IH}	High-Level Input Voltage	-	4.5V to 5.5V	2.0	-	2.0	-	V
V _{IL}	Low-Level Input Voltage	-	4.5V to 5.5V	-	0.8	-	0.8	V
V _{OH}	High-Level Output Voltage	I _{OH} = -50μA	4.5V	4.4	-	4.4	-	V
		I _{OH} = -8mA	4.5V	3.80	-	3.70	-	
V _{OL}	Low-Level Output Voltage	I _{OL} = 50μA	4.5V	-	0.1	-	0.1	V
		I _{OL} = 8mA	4.5V	-	0.44	-	0.55	
I _{OZ}	Z State Leakage Current	V _O = 0 to 5.5V	5.5V	-	±2.5	-	±10	μA
I _I	Input Current	V _I = GND to 5.5V	3.6V	-	±1	-	±2	μA
I _{CC}	Supply Current	V _I = GND or V _{CC} , I _O = 0	3.6V	-	20	-	40	μA
ΔI _{CC}	Additional Supply Current	One input at V _{CC} -2.1V Other pins at V _{CC} or GND	5.5V	-	1.35	-	5	mA

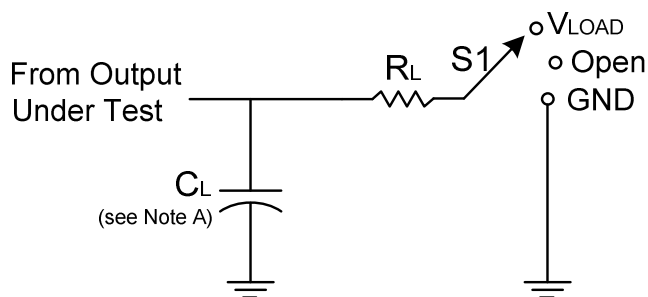
Operating Characteristics

Parameter		Test Conditions	V _{CC} = 5.5V	Unit
			Typ	
C _{pd}	Power Dissipation Capacitance per Gate	f = 1MHz	14.8	pF
C _i	Input Capacitance	V _I = V _{CC} – or GND	4.0	pF

Switching Characteristics (V_{CC} = 4.5V to 5.5V)

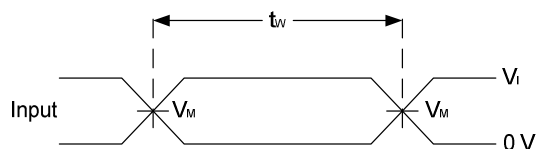
Symbol	Parameter	Test Conditions	T _A = +25°C			-40°C to +85°C		-40°C to +125°C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
t _{PD}	Propagation Delay A _N to Y _N	Figure 1 C _L = 15pF	0.5	3.0	5.5	0.5	6.5	0.5	7.0	ns
		Figure 1 C _L = 50pF	0.5	4.3	7.5	0.5	8.5	0.5	9.5	
t _{EN}	Enable Time $\overline{\text{OE}}_{\text{N}}$ to Y _N	Figure 1 C _L = 15 pF	0.5	3.3	5.1	0.5	6.0	0.5	6.5	ns
		Figure 1 C _L = 50pF	0.5	4.7	7.1	0.5	8.0	0.5	9.0	
t _{DIS}	Disable Time $\overline{\text{OE}}_{\text{N}}$ to Y _N	Figure 1 C _L = 15pF	0.5	4.8	6.8	0.5	8.0	0.5	8.5	ns
		Figure 1 C _L = 50pF	0.5	6.5	8.9	0.5	10.0	0.5	11.5	

Parameter Measurement Information

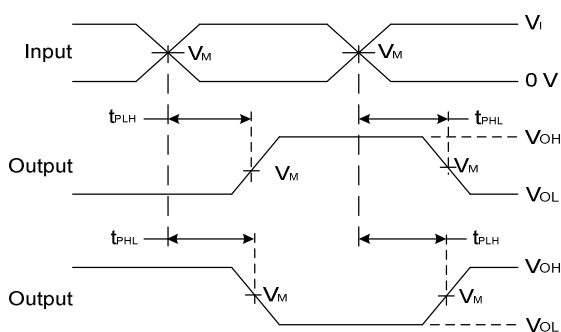


TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	V_{load}
t_{PHZ}/t_{PZH}	GND

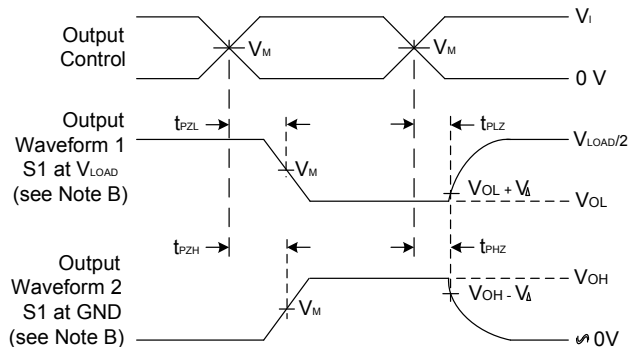
V_{CC}	Inputs		V_M Inputs	V_M Outputs	V_{LOAD}	C_L	R_L	V_{Δ}
	V_I	t_r/t_f						
4.5V to 5.5V	3 V	$\leq 3ns$	1.5 V	$V_{CC}/2$	V_{CC}	15pF, 50pF	1K	0.3V



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times
Inverting and Non Inverting Outputs



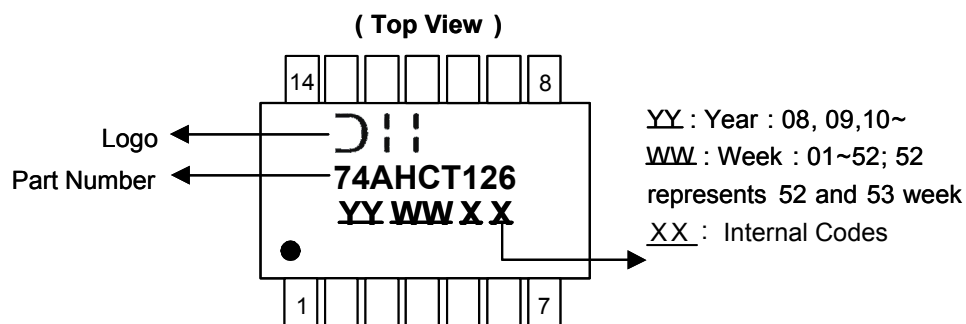
Voltage Waveform Enable and Disable Times
Low and High Level Enabling

Figure 1. Load Circuit and Voltage Waveforms

- Notes:
- A. Includes test lead and test apparatus capacitance.
 - B. All pulses are supplied at pulse repetition rate ≤ 1 MHz.
 - C. Inputs are measured separately one transition per measurement.
 - D. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - E. t_{PZL} and t_{PZH} are the same as t_{ENO} .
 - F. t_{PLH} and t_{PHL} are the same as t_{PD} .

Marking Information

(1) SO-14, TSSOP-14

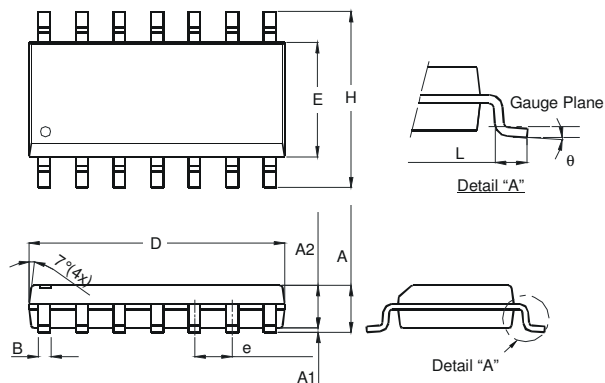


Part Number	Package
74AHCT126S14	SO-14
74AHCT126T14	TSSOP-14

Package Outline Dimensions (All dimensions in mm.)

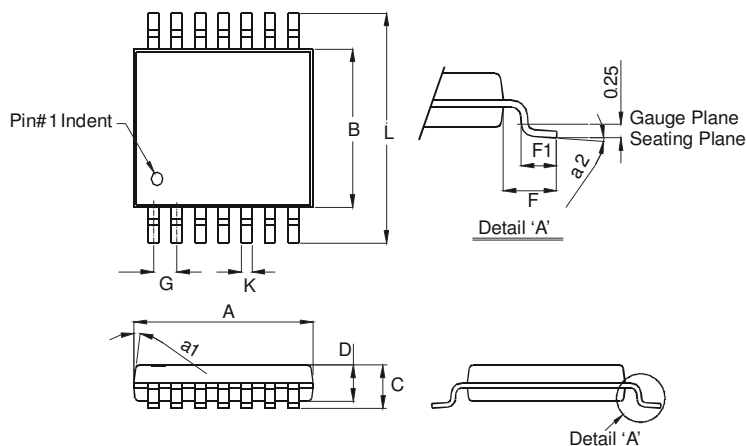
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

Package Type: SO-14



SO-14		
Dim	Min	Max
A	1.47	1.73
A1	0.10	0.25
A2	1.45 Typ	
B	0.33	0.51
D	8.53	8.74
E	3.80	3.99
e	1.27 Typ	
H	5.80	6.20
L	0.38	1.27
θ	0°	8°
All Dimensions in mm		

Package Type: TSSOP-14

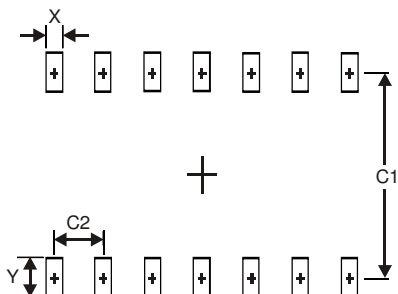


TSSOP-14		
Dim	Min	Max
a1	7° (4X)	
a2	0°	8°
A	4.9	5.10
B	4.30	4.50
C	—	1.2
D	0.8	1.05
F	1.00 Typ	
F1	0.45	0.75
G	0.65 Typ	
K	0.19	0.30
L	6.40 Typ	
All Dimensions in mm		

Suggested Pad Layout

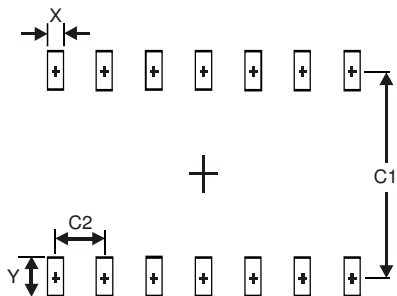
Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.

Package Type: SO-14



Dimensions	Value (in mm)
X	0.60
Y	1.50
C1	5.4
C2	1.27

Package Type: TSSOP-14



Dimensions	Value (in mm)
X	0.45
Y	1.45
C1	5.9
C2	0.65

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